

Gerburg Schider

List of Publications by Year in descending order

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Version: 2024-02-01

9
papers

110
citations

1478505

6
h-index

1588992

8
g-index

9
all docs

9
docs citations

9
times ranked

225
citing authors

#	ARTICLE	IF	CITATIONS
1	Smart Coreâ€Shell Nanostructures for Force, Humidity, and Temperature Multiâ€Stimuli Responsiveness. <i>Advanced Materials Technologies</i> , 2022, 7, .	5.8	10
2	Microstructured single-layer electrodes embedded in P(VDF-TrFE) for flexible and self-powered direction-sensitive strain sensors. <i>Smart Materials and Structures</i> , 2020, 29, 085040.	3.5	12
3	2D Semiconductors: Interfacial Band Engineering of MoS ₂ /Gold Interfaces Using Pyrimidineâ€Containing Selfâ€Assembled Monolayers: Toward Contactâ€Resistanceâ€Free Bottomâ€Contacts (<i>Adv. Electron. Mater.</i> 5/2020). <i>Advanced Electronic Materials</i> , 2020, 6, 2070026.	5.1	1
4	Interfacial Band Engineering of MoS ₂ /Gold Interfaces Using Pyrimidineâ€Containing Selfâ€Assembled Monolayers: Toward Contactâ€Resistanceâ€Free Bottomâ€Contacts. <i>Advanced Electronic Materials</i> , 2020, 6, 2000110.	5.1	18
5	Up-scalable ITO-free organic light emitting diodes based on embedded inkjet-printed copper grids. <i>Flexible and Printed Electronics</i> , 2019, 4, 025004.	2.7	12
6	Critical Evaluation of Organic Thin-Film Transistor Models. <i>Crystals</i> , 2019, 9, 85.	2.2	20
7	Printed Copper Nanoparticle Metal Grids for Costâ€Effective ITOâ€Free Solution Processed Solar Cells. <i>Solar Rrl</i> , 2018, 2, 1700192.	5.8	31
8	Large area processing and printing of conducting copper structures for use in (opto)electronics (Conference Presentation). , 2017, , .		0
9	A Two-Step Method to Covalently Bind Biomolecules to Group-IV Semiconductors: Si(111)/1,2-Epoxy-9-decene/Esterase. <i>Langmuir</i> , 2008, 24, 13957-13961.	3.5	6